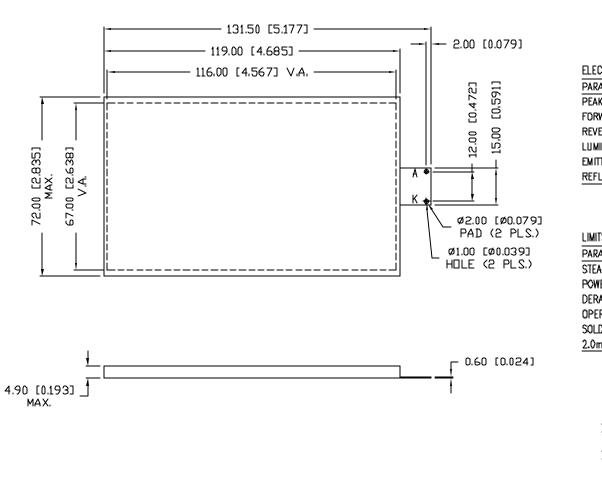
UNCONTROLLED DOCUMENT



## 

	*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECINAL PRECISION ARE: X=±1 (±0.039	I), XX=±0.5 (±0.02D), XXX=±0.25 (±0.010), XXXX=±0.127 (±0.005). LE	AD SIZE=±0.05 (±0.002), I	_ead length=±0.75 (±0.03	0), NIN= +0ecinal precisio -0.00	WAX.= +O.D DEC	ainal Precision
REV.	PART NUMBER	<u>confidential information</u> The information contained in this document is the property of	i isa		E. HELEN ROA ATINE. IL 6006	D 7-6976	
	$\Sigma = C \cup H \cup D \cup Z$	lumex NC. Except as specifically authorized in writing by lunex	Ma Zeroa Photona To Wo		MINE, 12 0000 NE: +1.847.359 WEB: www.lume: WEB: www.lume:	3.2790 x.com	
116mr	n x 67mm VIEW AREA, CHIP ON BOARD LED BACKLIGHT, 565nm GREEN, 220 CHIPS, 4.2V @ 1110mA.	<u>Reliability Notie</u> Our Nany Years of experience data accumulation indicate that solder heat is a major cause of early and future failure. Please pay attention to your soldering process.	DRAWN BY:		APPROVED BY:		7.1.04 1 OF 1 N/A



ELECTRO-OPTICAL CHA	RACTERISTI	CS T_=2	5°C PER MK	DULE	lf≕l100mA
PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH		565		nm	
FORWARD VOLTAGE		4.2	4.5	Vf	
REVERSE VOLTAGE	8			٧r	lr=11.0mA
LUMINOUS INTENSITY		340		cd/m²	lf≔11⊡Om A
EMITTED COLOR:	GREEN				
REFLECTOR FINISH:	WHITE				

## LIMITS OF SAFE OPERATION AT 25'C PER MODULE

110

PARAMETER	MAX	UNITS
STEADY CURRENT	2200	mA
POWER DISSIPATION	9,9	W
DERATE FROM 25°C, PER DIE	-1.2	m₩/°C
OPERATING, STORAGE TEMP.	- 40 TO + 85	<b>'</b> C
SOLDERING TEMP.	+ 260	<b>'</b> C
2.0mm FROM BODY		3 SEC. MAX

2 CHIPS IN SERIES 110 PARALLEL BRANCHES

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